

Initial Information Data Sheet

Inventor Information

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Inventor Three Given Name:: William S.
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Application Information

Title Line One::	METHODS FOR FILLING HIGH ASPECT RATIO
Title Line Two::	TRENCHES IN SEMICONDUCTOR LAYERS
Total Drawing Sheets::	4
Formal Drawings?::	Yes
Application Type::	Utility
Docket Number::	MIO 0109 PA/02-1541

Representative Information

Registration Number One::	26,397
Registration Number Two::	27,262
Registration Number Three::	29,001
Registration Number Four::	39,564
Registration Number Five::	38,769
Registration Number Six::	33,758
Registration Number Seven::	42,695
Registration Number Eight::	46,867
Registration Number Nine::	46,506
Registration Number Ten::	46,458
Registration Number Eleven::	52,364
Registration Number Twelve::	30,871
Registration Number Thirteen::	38,086